

技术要求Specification:

- 1、材质Material: PA66 UL94V-0:
- 2、额定电流 Current rating:2.0A AC,DC
- 3、额定电压 Voltage rating:250V AC,DC
- 4、温度范围 Temperature range:-25℃to+85℃
- 5、接触电阻 Contact resistance:≤20mΩ
- 6、绝缘电阻Insulation resistance:≥1000MΩ
- 7、耐压Withstand voltage:500V AC/minute
- 8、塑件表面平整光洁,无明显的毛刺、气泡、变形、浇口拉伤、缺料等不良现象。

Plastic surface smooth and clean, no obvious glitches, bubbles, distortion, gate strain, lack of material and other undesirable phenomena.

Part No	Pin	A	B	C	D	E
WAFER-HY2.0-2PJK	2	2.00	4.70	2.30	1.00	0.60
WAFER-HY2.0-3PJK	3	4.00	6.70	2.30	1.00	0.60
WAFER-HY2.0-4PJK	4	6.00	8.70	4.30	1.70	1.00
WAFER-HY2.0-5PJK	5	8.00	10.70	4.30	1.70	1.00
WAFER-HY2.0-6PJK	6	10.00	12.70	8.30	5.90	1.95
WAFER-HY2.0-7PJK	7	12.00	14.70	10.30	7.90	1.95
WAFER-HY2.0-8PJK	8	14.00	16.70	12.30	9.90	1.95
WAFER-HY2.0-9PJK	9	16.00	18.70	12.30	9.90	1.95
WAFER-HY2.0-10PJK	10	18.00	20.70	12.30	9.90	1.95
WAFER-HY2.0-11PJK	11	20.00	22.70	16.30	13.90	1.95
WAFER-HY2.0-12PJK	12	22.00	24.70	16.30	13.90	1.95
WAFER-HY2.0-13PJK	13	24.00	26.70	16.30	13.90	1.95
WAFER-HY2.0-14PJK	14	26.00	28.70	16.30	13.90	1.95
WAFER-HY2.0-15PJK	15	28.00	30.70	16.30	13.90	1.95
WAFER-HY2.0-16PJK	16	30.00	32.70	16.30	13.90	1.95

MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: HY2.0MM HOUSING
DECIMALS:	ANGLES:		PAR WAFER-HY2.0-NPJK
.X±0.30	X.*±1°		DWN
.XX±0.20			CHKD
.XXX±0.10			APVD
CUSTOMER COPY		SCALE:1:1	UNIT:MM
		SIZE:A4	SHEET:1F1
			REV:A